74CBTLVD3861

10-bit level-shifting bus switch with output enable

Rev. 4 — 14 December 2011

Product data sheet

1. General description

The 74CBTLVD3861 is a 10-bit 3.3 V to 1.8 V level translating bus switch with one output enable (OE) input. When OE is LOW, the switch is closed and port A is connected to the B port. When OE is HIGH, the switch is disabled.

To ensure the high-impedance OFF-state during power-up or power-down, $\overline{\text{OE}}$ should be tied to the V_{CC} through a pull-up resistor. The minimum value of the resistor is determined by the current-sinking capability of the driver.

Schmitt trigger action at control input makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 3.0 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF}.

2. Features and benefits

- Supply voltage range from 3.0 V to 3.6 V
- High noise immunity
- Complies with JEDEC standard:
 - ◆ JESD8-B/JESD36 (3.0 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- \blacksquare 4 Ω switch connection between two ports
- 3.3 V to 1.8 V level translation
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



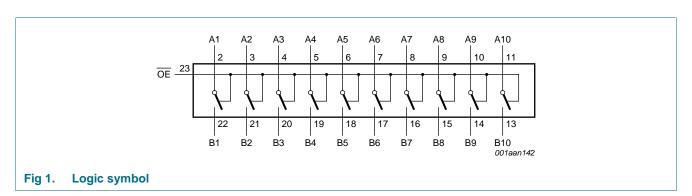
3. Ordering information

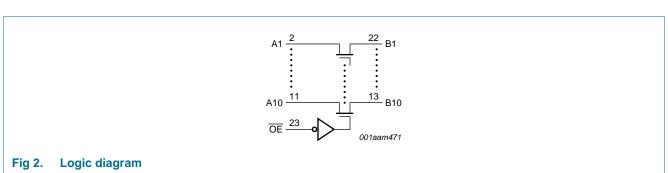
Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74CBTLVD3861DK	-40 °C to +125 °C	SSOP24[1]	plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT556-1
74CBTLVD3861PW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1
74CBTLVD3861BQ	−40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5\times5.5\times0.85$ mm	SOT815-1

^[1] Also known as QSOP24 package

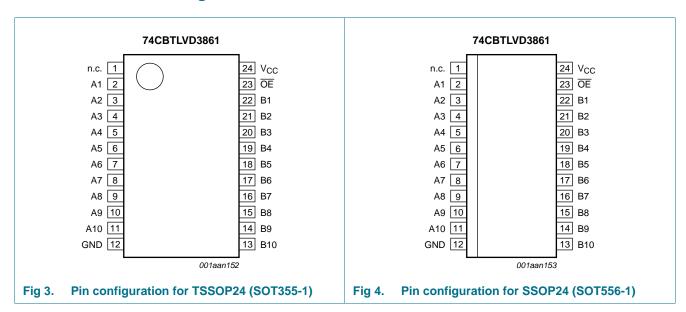
4. Functional diagram

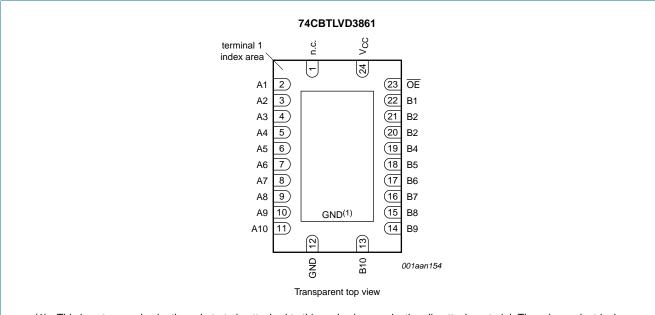




5. Pinning information

5.1 Pinning





(1) This is not a supply pin, the substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad however if it is soldered the solder land should remain floating or be connected to GND.

Fig 5. Pin configuration for DHVQFN24 (SOT815-1)

5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
nc	1	not connected
A1 to A10	2, 3, 4, 5, 6, 7, 8, 9, 10, 11	data input/output (A port)
GND	12	ground (0 V)
B1 to B10	22, 21, 20, 19, 18, 17, 16, 15, 14, 13	data input/output (B port)
OE	23	output enable input (active LOW)
V_{CC}	24	positive supply voltage

6. Functional description

Table 3. Function selection[1]

Input OE	Input/output
OE	An, Bn
L	An = Bn
H	Ζ

^[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
V_{I}	input voltage		<u>[1]</u> –0.5	+4.6	V
V_{SW}	switch voltage	enable and disable mode	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
I _{IK}	input clamping current	$V_1 < -0.5 V$	-50	-	mA
I _{SK}	switch clamping current	$V_{I} < -0.5 \text{ V}$	-50	-	mA
I _{SW}	switch current	$V_{SW} = 0 V \text{ to } V_{CC}$	-	±128	mA
I _{CC}	supply current		-	+100	mA
I_{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[2] -	500	mW

^[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^[2] For SSOP24 and TSSOP24 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C. For DHVQFN24 package: P_{tot} derates linearly at 4.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		3.0	3.6	V
V _I	input voltage		0	3.6	V
V_{SW}	switch voltage	enable and disable mode	0	V_{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V _{CC} = 3.0 V to 3.6 V	<u>[1]</u> _	200	ns/V

^[1] Applies to control signal levels.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		T _{amb} = -	-40 °C to	+85 °C	$T_{amb} = -40$ °	C to +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
V_{IH}	HIGH-level input voltage	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	'	2.0	-	-	2.0	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	-	0.9	-	0.9	V
II	input leakage current	pin $\overline{\text{OE}}$; V _I = GND to V _{CC} ; V _{CC} = 3.6 V		-	-	±1	-	±20	μΑ
V_{pass}	pass voltage	$V_I = V_{CC}$; see <u>Figure 8</u> to <u>Figure 12</u>		-	-	-	-	-	V
I _{S(OFF)}	OFF-state leakage current	V _{CC} = 3.6 V; see <u>Figure 6</u>		-	-	±1	-	±20	μΑ
I _{S(ON)}	ON-state leakage current	$V_{CC} = 3.6 \text{ V}$; see Figure 7		-	-	±1	-	±20	μΑ
I _{OFF}	power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V		-	-	±10	-	±50	μΑ
I _{CC}	supply current	$V_I = V_{CC}$; $I_O = 0$ A; $V_{CC} = 3.6$ V; $V_{SW} = GND$ or V_{CC}		-	-	20	-	50	μΑ
		$V_I = GND; I_O = 0 A;$ $V_{CC} = 3.6 V;$ $V_{SW} = GND \text{ or } V_{CC}$		-	-	100	-	150	μА
ΔI_{CC}	additional supply current	pin $\overline{\text{OE}}$; $V_{I} = V_{CC} - 0.6 \text{ V}$; $V_{SW} = \text{GND or } V_{CC}$; $V_{CC} = 3.6 \text{ V}$	[2]	-	-	300	-	2000	μА
C _I	input capacitance	pin \overline{OE} ; $V_{CC} = 3.3 \text{ V}$; $V_{I} = 0 \text{ V to } 3.3 \text{ V}$		-	0.9	-	-	-	pF
C _{S(OFF)}	OFF-state capacitance	$V_{CC} = 3.3 \text{ V}; V_I = 0 \text{ V to } 3.3 \text{ V}$		-	2.5	-	-	-	pF
C _{S(ON)}	ON-state capacitance	$V_{CC} = 3.3 \text{ V}; V_I = 0 \text{ V to } 3.3 \text{ V}$		-	9.0	-	-	-	pF

^[1] All typical values are measured at T_{amb} = 25 °C.

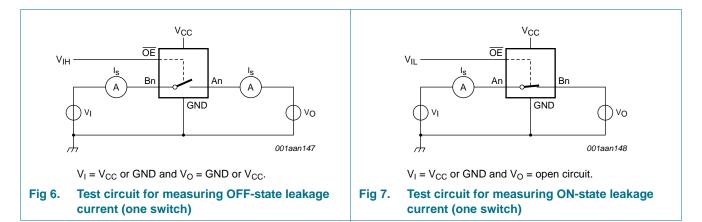
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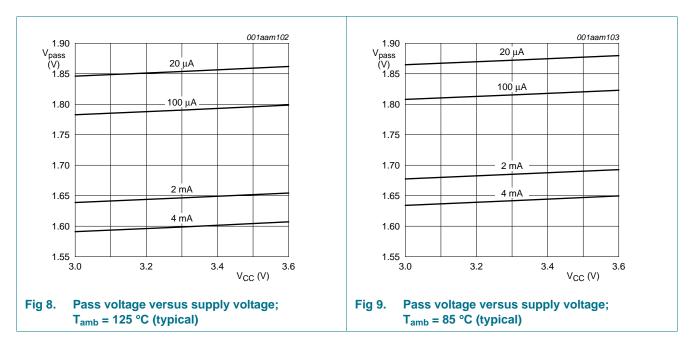
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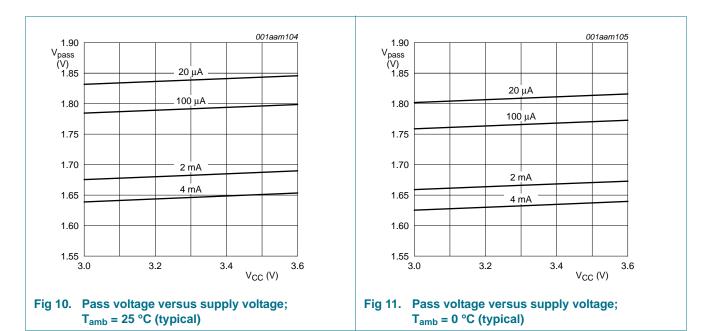
^[2] One input at 3 V, other inputs at V_{CC} or GND.

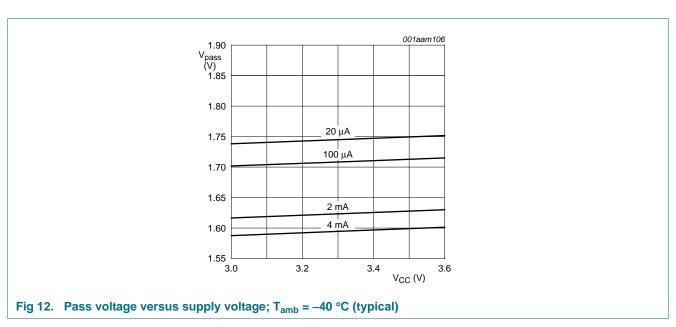
9.1 Test circuits



9.2 Typical pass voltage graphs







9.3 ON resistance

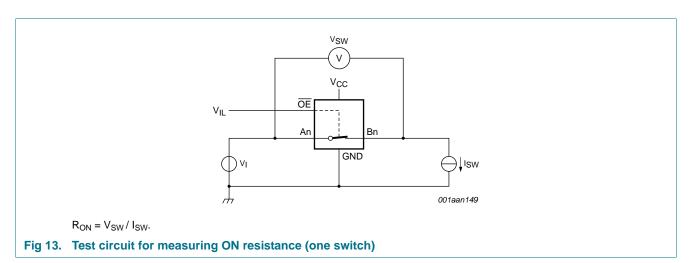
Table 7. Resistance RoN

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 13.

Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	+85 °C	T _{amb} = -40 °	C to +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
R _{ON} ON resi	ON resistance	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$				'		
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	3.7	7.0	-	10.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	3.7	7.0	-	10.0	Ω
		$I_{SW} = 15 \text{ mA}; V_I = 1.2 \text{ V}$	-	4.7	10.0	-	12.0	Ω

^[1] Typical values are measured at T_{amb} = 25 °C and nominal V_{CC} .

9.4 ON resistance test circuit



^[2] Measured by the voltage drop between the An and Bn terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (An or Bn) terminals.

10. Dynamic characteristics

Table 8. **Dynamic characteristics**

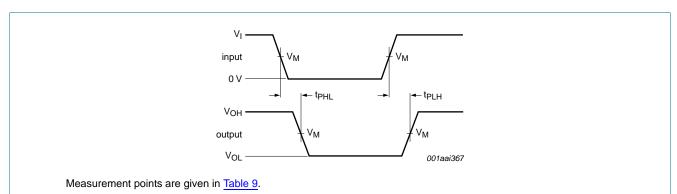
GND = 0 V; for test circuit see Figure 16

Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	T _{amb} = -40 °	C to +125 °C	ns
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	An to Bn or Bn to An; see Figure 14	[2][3]						
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	-	0.11	-	0.22	ns
t _{en} en	enable time	OE to An or Bn; see Figure 15	[4]						
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	2.9	5.0	1.5	6.0	ns
t _{dis}	disable time	OE to An or Bn; see Figure 15	<u>[5]</u>						
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		0.8	3.3	7.0	0.8	8.0	ns

^[1] All typical values are measured at T_{amb} = 25 °C and at nominal V_{CC} .

- t_{pd} is the same as t_{PLH} and t_{PHL} .
- ten is the same as tezh and tezh.
- t_{dis} is the same as t_{PHZ} and t_{PLZ}.

10.1 Waveforms



Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 14. The data input (An, Bn) to output (Bn, An) propagation delay times

Measurement points

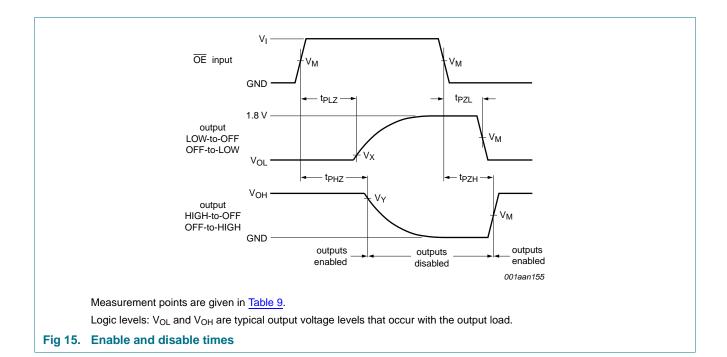
Supply voltage	Input			Output		
V _{CC}	V_{M} V_{I} $t_{r} = t_{f}$		V _M	V _X	V _Y	
3.0 V to 3.6 V	0.5V _{CC}	V _{CC}	\leq 2.0 ns	0.9 V	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$

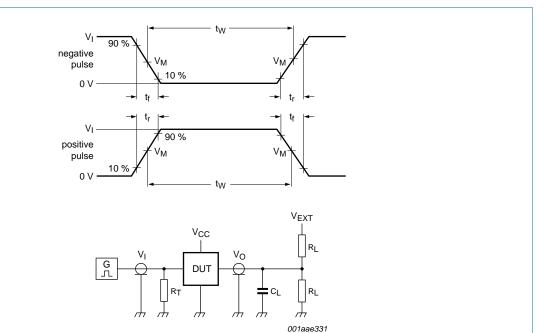
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Table 9.

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The propagation delay is the calculated RC time constant of the on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).





Test data is given in Table 10.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 16. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Load	V _{EXT}			
V _{CC}	C _L	R _L	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
3.0 V to 3.6 V	30 pF	1 kΩ	open	GND	3.6 V

10.2 Additional dynamic characteristics

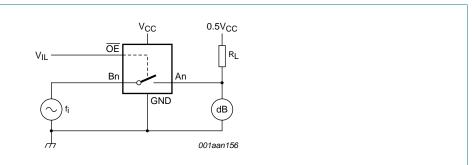
Table 11. Additional dynamic characteristics

GND = 0 V.

Symbol	Parameter	Conditions		T _{amb} = 25 °C			Unit
				Min	Тур	Max	
$f_{(-3dB)}$	-3 dB frequency response	V_{CC} = 3.3 V; R_L = 50 Ω ; see Figure 17	<u>[1]</u>	-	575	-	MHz

[1] f_i is biased at $0.5V_{CC}$.

10.3 Test circuit

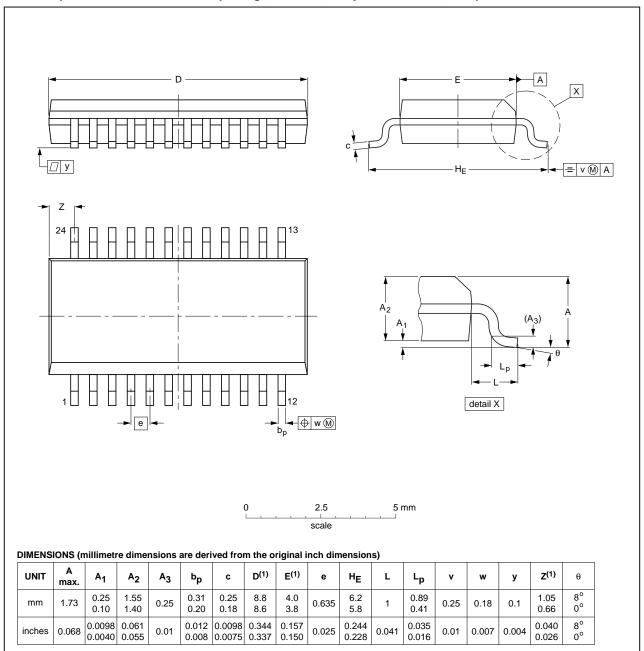


Adjust f_i voltage to obtain 0 dBm level at output. Increase f_i frequency until dB meter reads -3 dB.

Fig 17. Test circuit for measuring the frequency response when channel is in ON-state

11. Package outline

SSOP24: plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm SOT556-1



Note

1. Plastic or metal protrusions of 0.2 mm (0.008 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC JEDE		JEITA	PROJECTION	ISSUE DATE
SOT556-1		MO-137			99-12-27 03-02-18

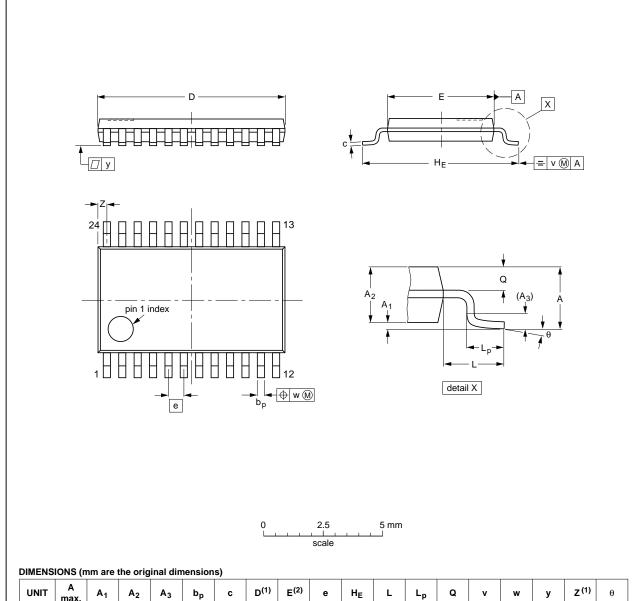
Fig 18. Package outline SOT556-1 (SSOP24)

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TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT355-1		MO-153				99-12-27 03-02-19	

Fig 19. Package outline SOT355-1 (TSSOP24)

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DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm

SOT815-1

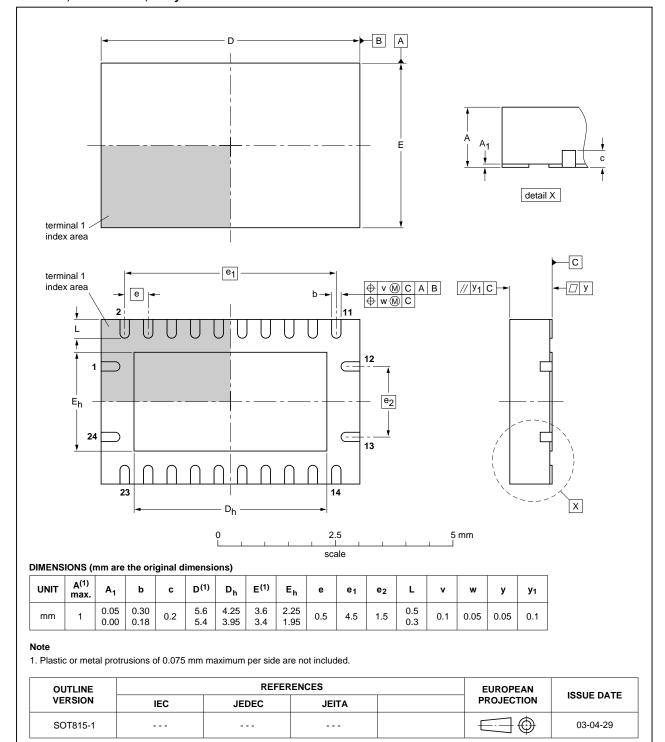


Fig 20. Package outline SOT815-1 (DHVQFN24)

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Product data sheet

12. Abbreviations

Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model

13. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74CBTLVD3861 v.4	20111214	Product data sheet	-	74CBTLVD3861 v.3
Modifications:	 Legal page 	s updated.		
74CBTLVD3861 v.3	20111020	Product data sheet	-	74CBTLVD3861 v.2
74CBTLVD3861 v.2	20110117	Product data sheet	-	74CBTLVD3861 v.1
74CBTLVD3861 v.1	20101206	Product data sheet	-	-

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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MT8986AE1 MT90812AP1 MT90869AG2 CA91L8260B-100CEV TC7MPB9307FT(EL) MT8986AP1 72V8985JG8 732757E

ZL50020QCG1 ZL50012QCG1 PI3C32X384BE PI5C3861QEX ZL50023GAG2 MT8986AL1 MT8981DP1 PI3VT3245-ALE

ZL50016GAG2 TC7MBL3257CFT(EL) PI3CH800QE MT90823AB1 ZL50075GAG2 PI5C32X245BEX PI5C3126QEX PI5C3125QEX PI3VT3245-AQE PI3CH800QEX PI3C3384QE PI3C3305UEX PI3B3861QEX PI3B3861QE PI3B32X245BEX PI3B3245QEX PI3B3245QEX PI3B3245QE PI3CH800ZHEX PI3CH1000LE PI3CH400ZBEX 728981JG8 TC7MBL3257CFK(EL) 728985JG8 PI3CH401LE

PI3CH401LEX FST3126DR2G QS34X245Q3G8 QS3VH125S1G8 TC7WBL3305CFK(5L,F 74CB3Q3125DBQRE4 74FST6800PGG8 74CB3Q3244DBQRE4 74CBTLV3125PGG8 TC7MBL3125CFT(EL)